

## WP934SA/LILYLGD

T-1 (3mm) Tri-Level Circuit Board Indicator



### DESCRIPTIONS

- The High Efficiency Red source color devices are made with Gallium Arsenide Phosphide on Gallium Phosphide Orange Light Emitting Diode
- The Yellow source color devices are made with Gallium Arsenide Phosphide on Gallium Phosphide Yellow Light Emitting Diode
- The Green source color devices are made with Gallium Phosphide Green Light Emitting Diode

#### **FEATURES**

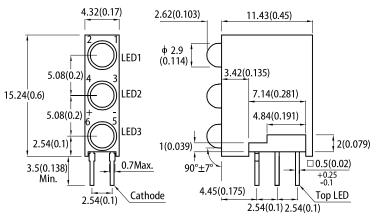
- · Pre-trimmed leads for pc mounting
- · Black case enhances contrast ratio
- · High reliability life measured in years
- Housing UL rating: 94V-0
- Housing material: Type 66 nylon
- · RoHS compliant

#### **APPLICATIONS**

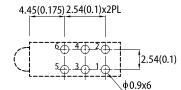
- Status indicator
- Illuminator
- Signage applications
- Decorative and entertainment lighting
- · Commercial and residential architectural lighting

### PACKAGE DIMENSIONS

LED1 : Red
LED2 : Yellow
LED3 : Green



**Recommended PCB Layout** 



#### Notes.

1. All dimensions are in millimeters (inches)

Tolerance is ±0.25(0.01") unless otherwise noted.
 Lead spacing is measured where the leads emerge from the package

The specifications, characteristics and technical data described in the datasheet are subject to change without prior notice.

#### **SELECTION GUIDE**

Part Number	Emitting Color (Material)	Lens Type	lv (mcd) @ 2mA <sup>[2]</sup>		Viewing Angle <sup>[1]</sup>
			Min.	Тур.	201/2
	High Efficiency Red	Red Diffused	0.8	2	50°
	WP934SA/LILYLGD		*0.5	*1.2	
WP934SA/LILYLGD		Yellow Diffused	0.8	3	-0°
	Yellow (GaAsP/GaP)		*0.8	*3	50°
	Green (GaP)	Green Diffused	1	3	50°
		Green Dilused	*1	*3	50

Notes

- 1. 01/2 is the angle from optical centerline where the luminous intensity is 1/2 of the optical peak value.
   2. Luminous intensity / luminous flux: +/-15%.
   \* Luminous intensity value is traceable to CIE127-2007 standards.

#### ELECTRICAL / OPTICAL CHARACTERISTICS at T<sub>A</sub>=25°C

Parameter	Querra ha l		Value		
	Symbol	Emitting Color	Тур.	Max. Unit	
Wavelength at Peak Emission $I_F$ = 2mA	$\lambda_{peak}$	High Efficiency Red Yellow Green	627 590 565	-	nm
Dominant Wavelength I <sub>F</sub> = 2mA	λ <sub>dom</sub> <sup>[1]</sup>	High Efficiency Red Yellow Green	617 588 568	-	nm
Spectral Bandwidth at 50% $\Phi$ REL MAX I <sub>F</sub> = 2mA	Δλ	High Efficiency Red Yellow Green	45 35 30	-	nm
Capacitance	с	High Efficiency Red Yellow Green	15 20 15	-	pF
Forward Voltage I <sub>F</sub> = 2mA	V <sub>F</sub> <sup>[2]</sup>	High Efficiency Red Yellow Green	1.7 1.85 1.9	2.1 2.2 2.25	V
Reverse Current ( $V_R$ = 5V)	I <sub>R</sub>	High Efficiency Red Yellow Green	-	10 10 10	μΑ
Temperature Coefficient of $\lambda_{\text{peak}}$ $I_F$ = 2mA, -10°C $\leq$ T $\leq$ 85°C	TC <sub>λpeak</sub>	High Efficiency Red Yellow Green	0.13 0.12 0.1	-	nm/°C
Temperature Coefficient of $\lambda_{dom}$ $I_F$ = 2mA, -10°C $\leq T \leq 85^\circ C$	TC <sub>λdom</sub>	High Efficiency Red Yellow Green	0.06 0.07 0.06	-	nm/°C
Temperature Coefficient of $~V_F$ $I_F$ = 2mA, -10°C $\leq$ T $\leq$ 85°C	TCv	High Efficiency Red Yellow Green	-1.9 -2 -2	-	mV/°C

Notes:

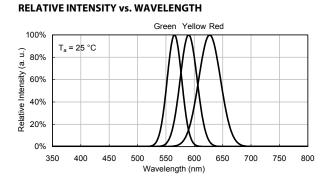
The dominant wavelength (λd) above is the setup value of the sorting machine. (Tolerance λd : ±1nm.)
 Forward voltage: ±0.1V.
 Wavelength value is traceable to CIE127-2007 standards.
 Excess driving current and / or operating temperature higher than recommended conditions may result in severe light degradation or premature failure.

#### ABSOLUTE MAXIMUM RATINGS at T<sub>A</sub>=25°C

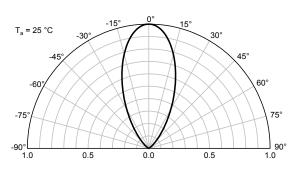
Parameter	Symbol	Value			Unit
		High Efficiency Red	Yellow	Green	Onit
Power Dissipation	P <sub>D</sub>	75	75	62.5	mW
Reverse Voltage	V <sub>R</sub>	5			V
Junction Temperature	Tj	125	110	110	°C
Operating Temperature	T <sub>op</sub>	-40 to +85			°C
Storage Temperature	T <sub>stg</sub>	-40 to +85			°C
DC Forward Current	I <sub>F</sub>	30	30	25	mA
Peak Forward Current	I <sub>FM</sub> <sup>[1]</sup>	160	140	140	mA
Electrostatic Discharge Threshold (HBM)	-	8000	8000	8000	V
Thermal Resistance (Junction / Ambient)	R <sub>th JA</sub> <sup>[2]</sup>	680	690	680	°C/W
Thermal Resistance (Junction / Solder point)	R <sub>th JS</sub> <sup>[2]</sup>	450	450	460	°C/W
Lead Solder Temperature [3]		260°C For 3 Seconds			
Lead Solder Temperature [4]		260°C For 5 Seconds			

Notes: 1. 1/10 Duty Cycle, 0.1ms Pulse Width. 2. R<sub>th. JA</sub>, R<sub>evis</sub> Results from mounting on PC board FR4 (pad size ≥ 16 mm<sup>2</sup> per pad). 3. 2mm below package base. 4. 5mm below package base. 5. Relative humidity levels maintained between 40% and 60% in production area are recommended to avoid the build-up of static electricity – Ref JEDEC/JESD625-A and JEDEC/J-STD-033.

### **TECHNICAL DATA**

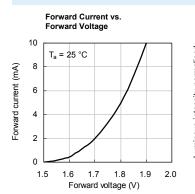


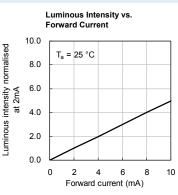
#### SPATIAL DISTRIBUTION



**HIGH EFFICIENCY RED** 

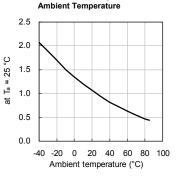
YELLOW

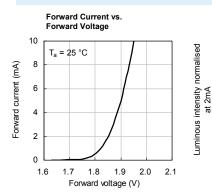




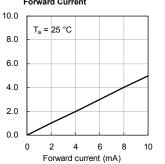
Forward Current Derating Curve 50 Permissible forward current (mA) -uminous intensity normalised 40 30 20 10 0 -40 -20 0 20 40 60 80 100 Ambient temperature (°C)

Luminous Intensity vs.





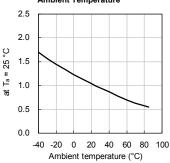
Luminous Intensity vs. Forward Current



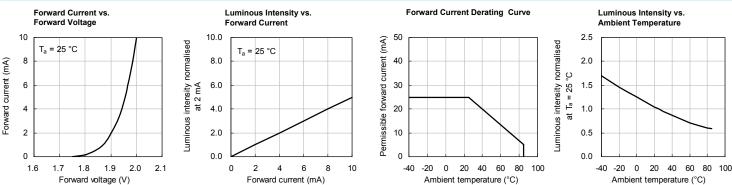
Forward Current Derating Curve

50 forward current (mA) Luminous intensity normalised 40 30 20 Permissible 10 0 -40 -20 0 20 40 60 80 100 Ambient temperature (°C)

Luminous Intensity vs. Ambient Temperature

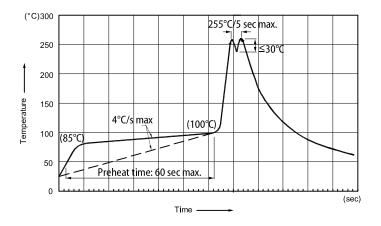


GREEN



at

#### **RECOMMENDED WAVE SOLDERING PROFILE**



Notes

- 1. Recommend pre-heat temperature of 105°C or less (as measured with a thermocouple attached to the LED pins) prior to immersion in the solder wave with a maximum solder bath temperature of 260°C
- 2. Peak wave soldering temperature between 245°C ~ 255°C for 3 sec (5 sec max)
- Do not apply stress to the epoxy resin while the temperature is above 65°C.
   Fixtures should not incur stress on the component when mounting and during soldering process.
- 5. SAC 305 solder alloy is recommended. 6. No more than one wave soldering pass.

PRECAUTIONS

#### **Storage Conditions**

- 1. Avoid continued exposure to the condensing moisture environment and keep the product away from rapid transitions in ambient temperature.
- 2. LEDs should be stored with temperature  $\leq$  30°C and relative humidity < 60%.
- 3. Product in the original sealed package is recommended to be assembled within 72 hours of opening. Product in opened package for more than a week should be baked for 30 (+10/-0) hours at 85 ~ 100°C.

#### **LED Mounting Method**

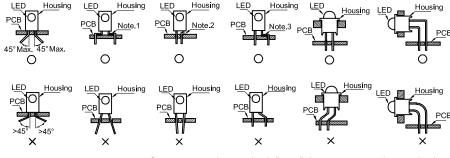
1. The lead pitch of the LED must match the pitch of the mounting holes on the PCB during component placement. Lead-forming may be required to insure

the lead pitch matches the hole pitch.

Refer to the figure below for proper lead

forming procedures. Note 1-3: Do not route PCB trace in the contact area between the

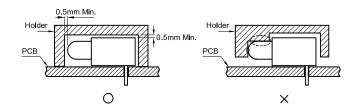
leadframe and the PCB to prevent short-circuits.



○ " Correct mounting method " x " Incorrect mounting method

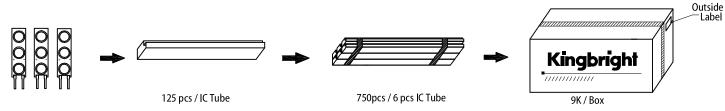
#### Lead Forming Procedures

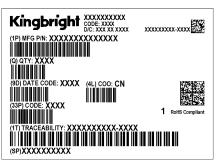
- 1. During soldering, component covers and holders should leave clearance to avoid placing damaging stress on the LED during soldering.
- 2. The tip of the soldering iron should never touch the lens epoxy.
- 3. Through-hole LEDs are incompatible with reflow soldering.
- 4. If the LED will undergo multiple soldering passes or face other processes where the part may be subjected to intense heat, please check with Kingbright for compatibility.



## WP934SA/LILYLGD

#### **PACKING & LABEL SPECIFICATIONS**





- PRECAUTIONARY NOTES
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